

a YAGEO company Tantalum Capacitors Technology

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Influences on Capacitors, How Materials and Environmental Effects Influence Capacitor Performance

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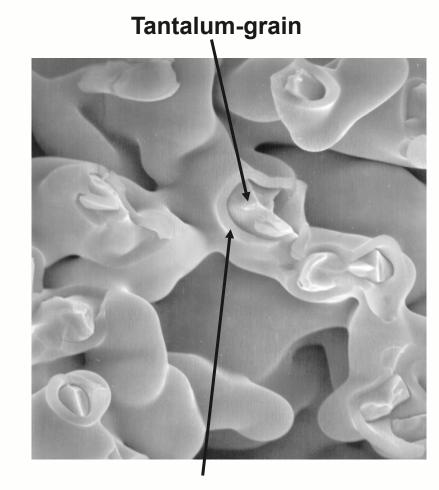
Outline

- Tantalum Capacitors
 - History and Future Path
 Polymer Advantages
 Materials and Manufacturing Technology
- Key Take Aways



Capacitors manufactured from Tantalum metal

- Discover in 1802 by Mr.A.G.Ekeberg
- Explored in Sweden, Finland, Americas, Australia and Africa
- Presents chemical stability (exceptional resistance to several chemical agents and to a great variety of acids)
- $-Ta_2O_5$ is quite stable in temperature; and its forming and density are totally controlled by electrochemical.



History



Tantalum Capacitor

History



T599 (150°C)



Future Path



	General Purpose			Automotive	High Reliability
SEGMENTS		TELECOM	INDUSTRIAL	AUTOMOTIVE	DEFENSE & AEROSPACE
APPLICATIONS	Tablets Laptops USB Type C Smart Phones	Solid State Drives Servers Telecom 5G	Embedded Power Management Industrial Equipment Internet of Things	Infotainment ADAS, Autonomous Driving Safety &Power Train	Radar Systems Communication Launch Systems Satellites Avionics
TRENDS	Ultra Thin Packages High Density Boards	Highest Energy Density Extended Mission Profiles	Miniaturization Higher voltages in smaller case sizes	H/EV = Electrification 48V power lines Autonomous And Connectivity	Power Efficiency GaN Miniaturization Bulk Capacitance

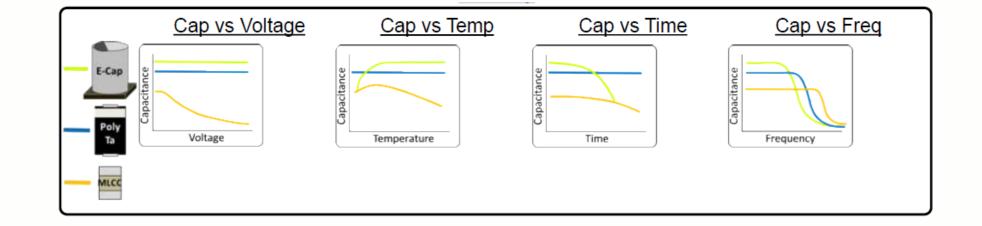


New Tantalum Polymer Capacitors Adoption and Growth will continue!

Polymer Advantages



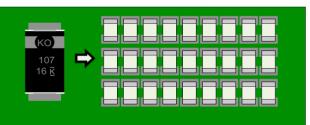
 Polymer Capacitors offer stable capacitance compared to other capacitors



MLCC vs Polymer

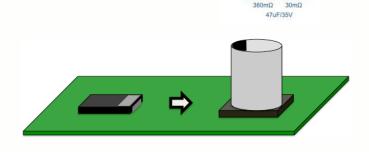
- No Piezo Noise
- Board saving Piece Count Reduction





Electrolytic vs Polymer

- Low profile
- High Ripple Capability
- Long Life Time



Tantalum MnO₂ vs Polymer

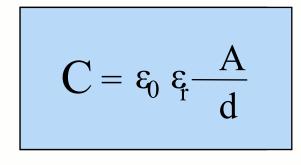
 No ignition failure mode

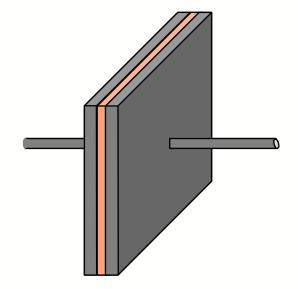
• Less De-rating



Principle







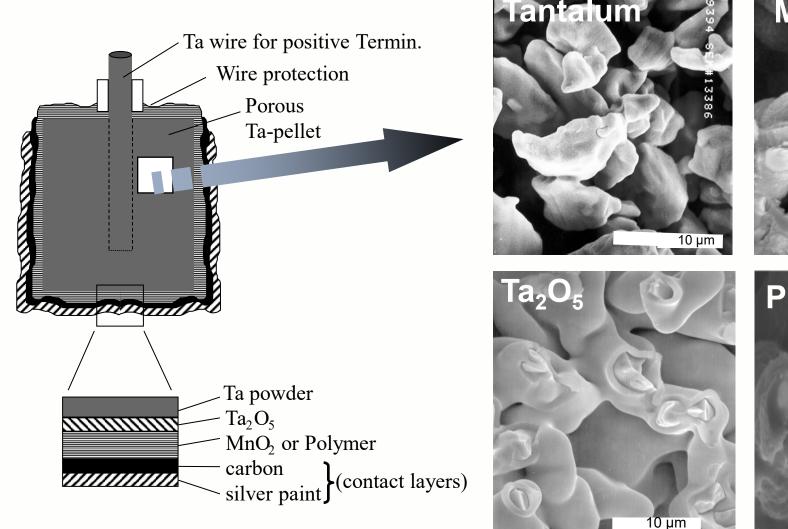
- □ High volumetric efficiency
 - $\epsilon_{Ta_2O_5} = 27$
 - $\mathbf{E}_{Al_2O_3} = 9$

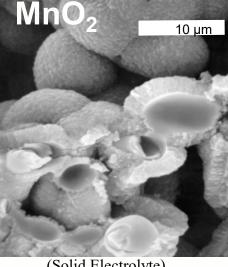
- C capacitance (ability to store electrical energy)
- ϵ_0 natural constant 8,85*10⁻¹² F/m
- ε_{r} dielectric constant (material property)
- A area of the electrode
- d thickness of dielectric layer

 Suitable for space restricted applications

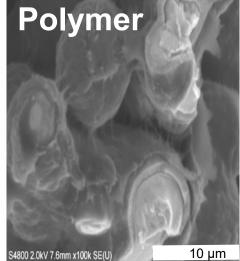
Layer by Layer





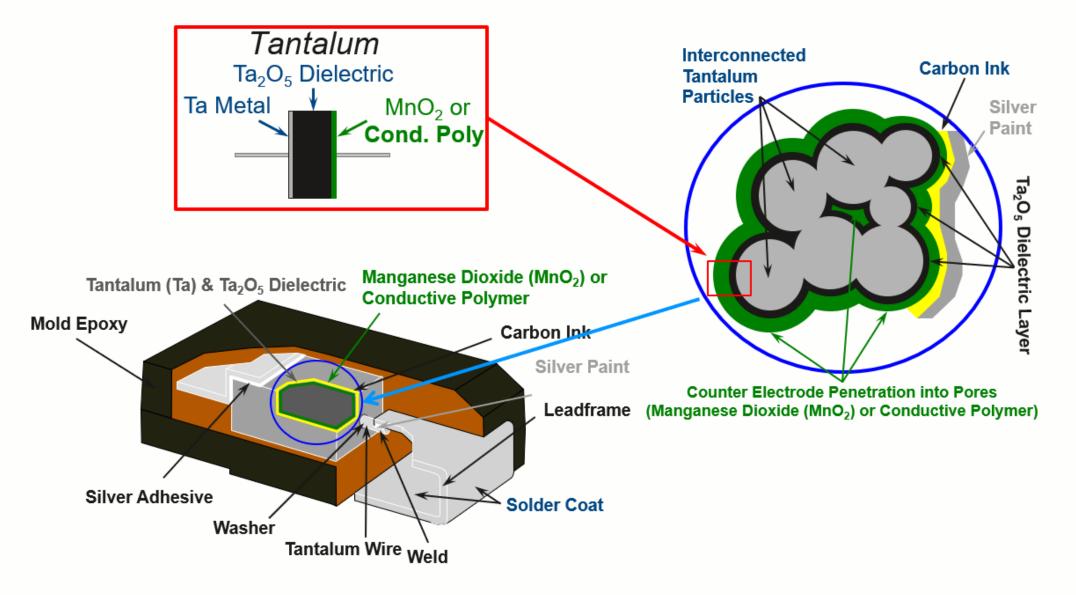


(Solid Electrolyte)



Cross section

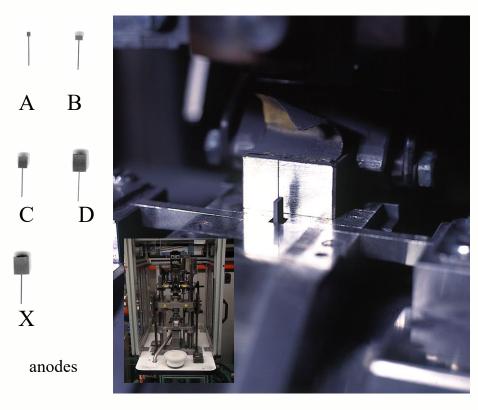




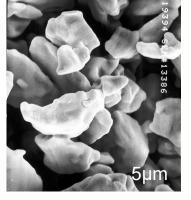
Pressing/Sintering



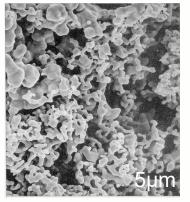
- Tantalum powder preparation (T, t)
- Powder mixed with binder and lubricant



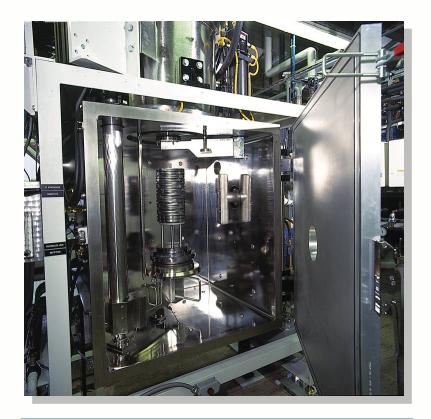
- Pressing anodes (Weight, dimensions – SPC)



High Voltage Low Capacitance



Low Voltage High Capacitance

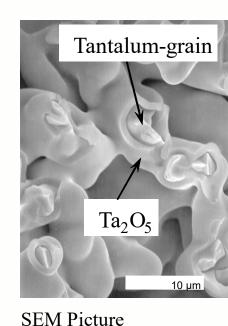


The anodes are sintered in a vacuum chamber at temperatures up to 2000°C for 15 min and pressures << 1 • 10⁻⁴ Pa

Ta₂O₅ Build Up



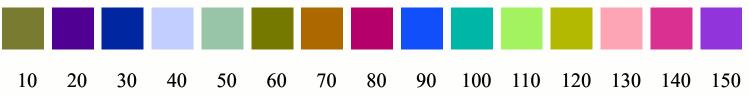




- Conductivity
- Temperature
- Current
- Time
- Voltage
- Capacitance
- Electrolyte []
- Fe/Al contaminations

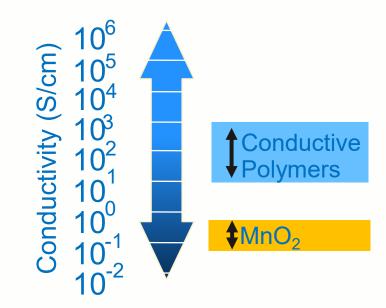
Anodic Oxidation: The anodes are immersed in electrolytic baths. By applying voltage, the dielectric Ta_2O_5 of the capacitor is formed.

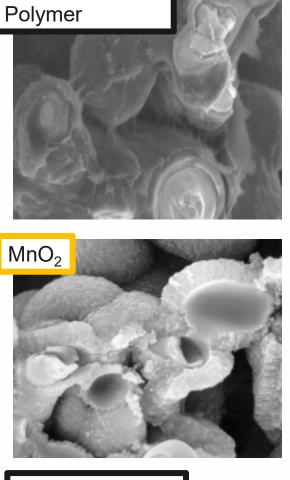
Dependence of the interference colour and the formation voltage



Counter Electrode







Conductive Organic Polymer

Polymerization reaction with monomer and oxidant at lower temperature; 'soft thin film'. Different chemistry settings available.

• MnO₂ is Manganese Dioxide

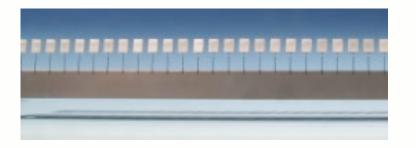
Brittle semiconductor material obtained by thermal decomposition at ~260°C of manganese nitrate

External Layers

Interface Layers (carbon / silver)

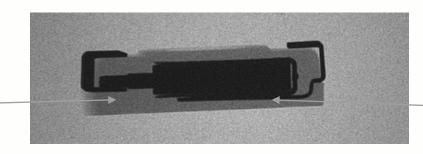
Assembly

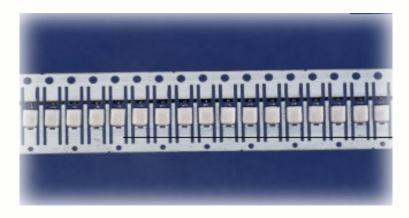




- R Capacitor is mounted on the leadframe
- R Glued with silver adhesive
- R The wire is cut and welded to the leadframe
- ® Support bar is removed

<u>Anode</u>: Welding



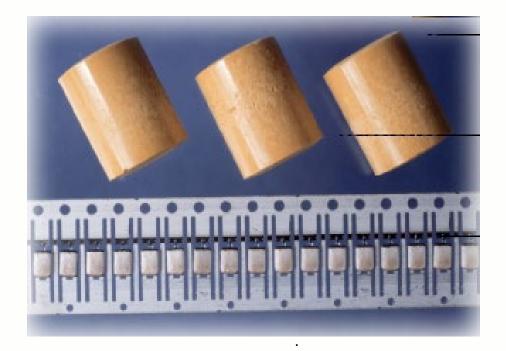


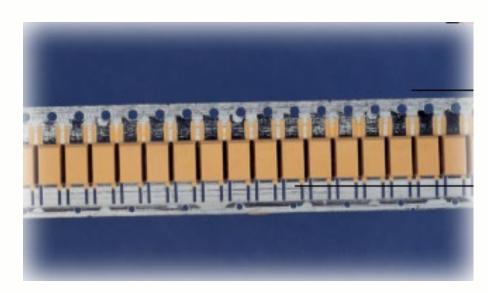
- R Control cameras for:
 - the adhesive quantity
 - pellet position
- R Defects are marked and removed later

<u>Cathode</u>: Silver Adhesive

Molding







MOLDING: the capacitor is encapsulated to give mechanical stability and to allows laser marking.

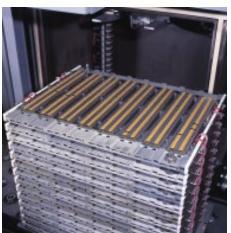
Marking/Aging





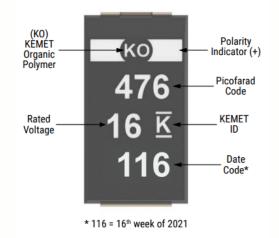
Lasermarking and Inspection:

- -The capacitors are inspected (
- Not completely molded or dirty parts are removed.
- Marking is applied, the date code allows traceability



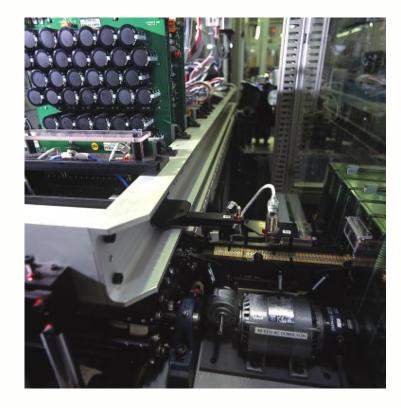
Aging:

- -The capacitors are stressed by applying a voltage $(>U_R)$ and high temperature (125°C).
- -A series resistance is used.



Testing





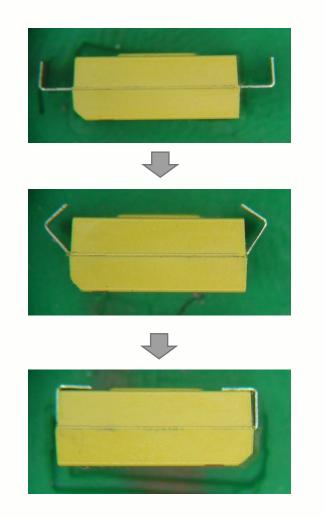
100% testing of electrical parameters for all the capacitors

- ☆ capacitance (120Hz)
- ☆ leakage current
- ☆ impedance (100kHz)
- ☆ dissipation factor (120Hz)
- Internal limits stricter than the specified limits
- 100 In-rush test is applied (several pulses, low series resistance, high current)
- The bad parts are cut out of the leadframe
- Detail test protocol for each lot with statistic information of the tested parameters

-Before <u>Tape and Form</u> the protocols are evaluated by the Conformity tests personal

Form/Tape/Shipment







Final Inspection before warehouse delivery (visual inspection, documentation check)



- Tantalum Capacitors are solid electrolyte capacitors and were introduced in the 50's using legacy MnO₂ counter electrode.
- On the 90's the new Polymer conductive counter electrode technology started mass production and during the last 2 decades R&D and NPD has supported adoption and business growth.
- The design and manufacturing process are complex and are continuously improved;
- KEMET is positioned to take proactive steps with following objectives:
 - Be a competitive permanent supplier of MnO₂ capacitors
 - Continue the expansion of Polymer capacitors into future applications
 - Continue the introduction of Polymer capacitors in Transportation and High Reliability apps.



